

General Features

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Load switch
- PWM application

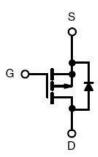
Product Summary



BVDSS	-60	V
RDS(on)Typ.@VGS=-10V	62	mΩ
ID	-12	Α



TO-252-2L top view



Schematic diagram

Absolute Maximum Ratings (T_C=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-60	V
Gate-Source Voltage	V _G S	±20	V
Drain Current-Continuous	I _D	-12	А
Pulsed Drain Current	I _{DM}	-48	А
Maximum Power Dissipation	P _D	50	W
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	℃

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	Reuc	3.0	°C/W
Thermal Resistance, Junction-to-Ambient	Reja	50	°C/W



Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u> </u>					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>		•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1.0	1.9	-2.5	V
Drain Course On State Besistance	Б	V _{GS} =-10V, I _D =-14A	-	62	70	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-10A	-	78	90	mΩ
Forward Transconductance	g Fs	V _{DS} =-5V,I _D =-14A	-	10	-	S
Dynamic Characteristics (Note4)	<u> </u>		•			
Input Capacitance	C _{lss}	\/ 20\/\/ 0\/	-	968	-	PF
Output Capacitance	C _{oss}	V _{DS} =-30V,V _{GS} =0V,		88	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	36	-	PF
Switching Characteristics (Note 4)	<u> </u>		•			
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	t _r	V_{DD} =-30V, R_L =2 Ω ,	-	4	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{G} =3 Ω	-	32	-	nS
Turn-Off Fall Time	t _f		-	7	-	nS
Total Gate Charge	Qg	V 00 L 44A	-	25	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-30, I_{D} =-14A,	-	3	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V		7	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-14A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-12	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =- 14A	-	25		nS
Reverse Recovery Charge	Qrr	$di/dt = -100A/\mu s^{(Note3)}$	-	31		nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics (Curves)

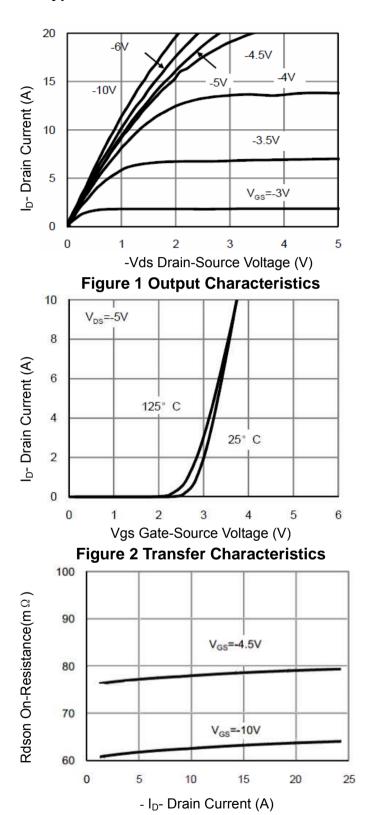
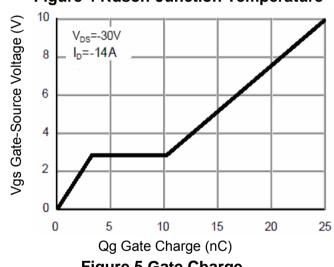


Figure 3 Rdson- Drain Current

2.00 Normalized On-Resistance 1.80 V_{GS}=-10V I_D=-14A 1.60 1.40 1.20 V_{gs}=-4.5V I_D=-10A 1.00 0.80 25 50 75 100 125 150 175 0 T_J-Junction Temperature(°C) **Figure 4 Rdson-Junction Temperature**



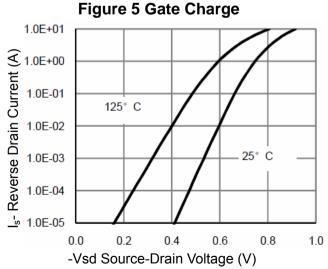


Figure 6 Source- Drain Diode Forward



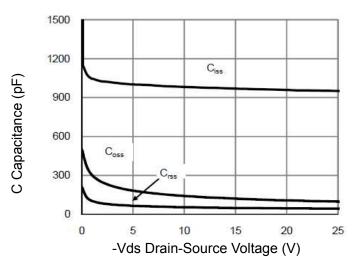


Figure 7 Capacitance vs Vds 1000.0 100.0 10μs I_D- Drain Current (A) R_{DS(ON)} limited 10.0 100μs 1_{ms} 10_{ms} 1.0 DC T_{J(Max)}=175° C 0.1 T_C=25° C 0.0 0.01 100 -Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area

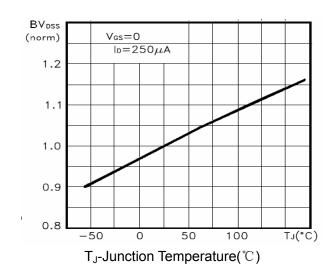


Figure 9 BV_{DSS} vs Junction Temperature 12 -I_D- Drain Current (A) 10 8 6 4 2 0 0 100 125 150 175 T_J-Junction Temperature(°C)

Figure 10 ID Current De-rating

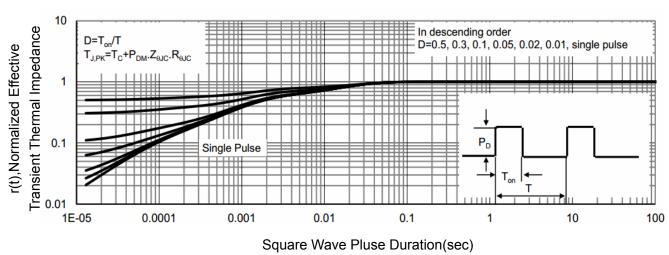


Figure 11 Normalized Maximum Transient Thermal Impedance

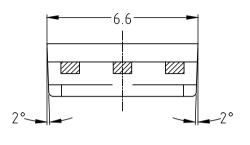
Ordering and Marking Information

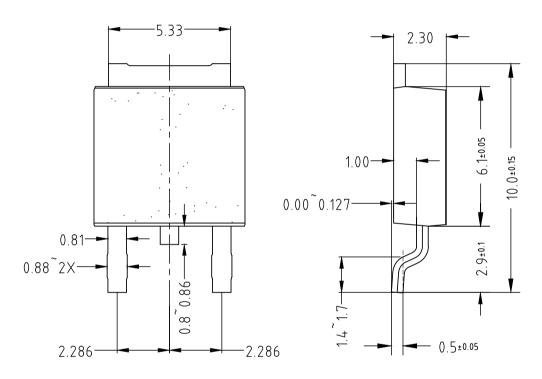
Ordering Device No.	Marking	Package	Packing	Quantity
ASDM60P12KQ-R	60P12	TO-252	Tape&Reel	2500/Reel

PACKAGE	MARKING
TO-252	AS Date Code Lot Number 60P12 Date Code



TO-252







ASDM60P12KQ

-60V P-Channel MOSFET

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